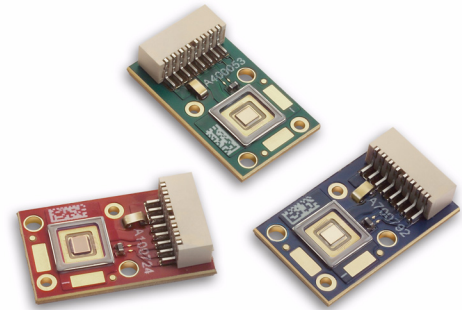


PhlatLight™ PT54 Projection Chipset



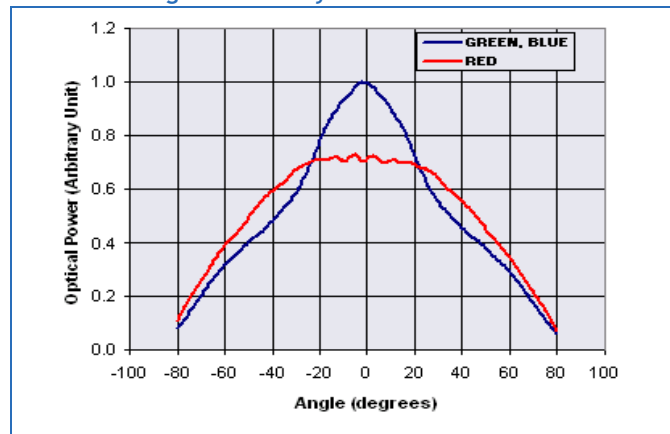
Technology Overview

Luminus Devices' Projection Technology is an innovative solid-state light source created to replace arc lamps in projection systems. Enabled by unique use of Photonic Lattice technology, PhlatLight chipsets represent a major breakthrough in brightness that delivers all the benefits of solid state light sources in projections applications:

- Wide color gamut for vivid colors, exceeds NTSC.
- Instant turn-on, no more wait time.
- High reliability; no lamp replacement
- Environmentally friendly technology - Mercury-free.
- Electronic control of color points and light intensity on a frame by frame basis

PhlatLight products benefit from numerous innovations in the domain of packaging, thermal management and optical coupling that allow designers to achieve efficient light engine designs and deliver high screen brightness.

Collimated Angular Intensity Distribution



Features

- Matched RGB Chipset with 5.4mm² emitting area designed for small projector applications
- Photonic lattice technology for very high surface brightness
- Wide color gamut: RED 623 nm, GREEN 526 nm, BLUE 462 nm, EP-Blue 460nm typical dominant wavelength
- Single emitting area per color allows for collection with single lens for simplified optics
- 4:3 Aspect ratio optimized for SVGA and XGA micro-displays
- Over 1575 emitted white lumens at 8000K color temperature from single chipset under Continuous Wave Operation
- Uniform surface emission
- Thermally efficient Type CX Common Anode package
- RoHS compliant (EU-2002/95/EC Directive)

Applications

- Specifically engineered for high brightness pocket-size, ultra portable front projectors, head-up projection displays
- Optimized for Micro-Display diagonal sizes ranging from 0.4" to 0.6" with 4:3 aspect ratio.

Suitable for DLP™ (0.55" SVGA and XGA), LCoS, 3LCD (0.55" SVGA and XGA) and HTPS microdisplays

Optical and Electrical Characteristics

	Symbol	Red	Green	Blue	EP-Blue ¹ Preliminary	Unit
Bin Kit		MPB	MPB	MPB	EPA	
Emitting Area		5.4	5.4	5.4	5.4	mm ²
Emitting Area Dimensions		2.7x2.0	2.7x2.0	2.7x2.0	2.7x2.0	mmxmm
Characteristics at Reference Pulsed Drive Current $I_F^{2,3}$						
Reference Duty Cycle ⁴		25	50	25	25	%
Recommended Peak Drive Current ⁵	typ I_F	13.5	13.5	13.5	13.5	A
Peak Luminous Flux ⁶	typ Φ_V	750	1550	275	325	lm
Peak Radiometric Power	typ Φ_r	4.2	3.3	5.6	7.7	W
Dominant Wavelength	min λ_{dmin}	619	516	455	450	nm
	typ λ_d	623	525	462	460	nm
	max λ_{dmax}	630	535	469	468	nm
FWHM - Spectral bandwidth at 50% of Φ_V	typ $\Delta\lambda_d$	19	38	20	20	nm
Color Saturation ^{7,8}	typ	1.00	0.80	0.99	0.99	
Chromaticity Coordinates ^{7,8}	typ x	0.697	0.171	0.144	0.154	
	typ y	0.303	0.702	0.040	0.024	
Forward Voltage	min V_{Fmin}	2.2	3.5	3.5	3.2	V
	typ V_F	2.6	4.9	4.9	4.0	V
	max V_{Fmax}	3.4	5.9	5.9	5.2	V
Dynamic Resistance	typ Ω_{dyn}	0.05	0.09	0.07	0.05	Ω
Device Thermal Characteristics and Lifetime						
Thermal Coefficient of Photometric Flux	typ	-1.0	-0.2	-0	-0	% / °C
Thermal Coefficient of Radiometric Flux	typ	-0.6	-0.2	-0.2	-0.2	% / °C
Forward Voltage Temperature Coefficient	typ	-1.5	-1.0	-3.0	-3.0	mV / °C
Median Lifetime ⁹		>60,000	>60,000	>60,000	>60,000	Hours

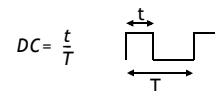
Optical and Electrical Characteristics

	Symbol	Red	Green	Blue	EP-Blue ¹ Preliminary	Unit
Bin Kit		MPB	MPB	MPB	EPA	A
Characteristics at Reference Continuous Drive Current I_F (continuous wave) ²						
Reference Drive Current	typ I_F	8.1	8.1	8.1	8.1	A
Luminous Flux	typ Φ_V	420	1085	200	235	lm
Radiometric Flux	typ Φ_r	2.3	2.2	3.7	5.1	W
Dominant Wavelength	typ λ_d	624	528	464	462	nm
FWHM - Spectral bandwidth at 50% of Φ_V	typ $\Delta\lambda_d$	18	38	21	21	nm
Color Saturation ^{7,8}	typ	1.00	0.84	0.99	0.99	
Chromaticity Coordinates ^{7,8}	typ x	0.698	0.183	0.141	0.153	
	typ y	0.301	0.703	0.044	0.025	
Forward Voltage	min V_{Fmin}	2.0	3.1	3.1	2.8	V
	typ V_F	2.3	4.4	4.4	3.6	V
	max V_{Fmax}	3.0	5.3	5.3	4.6	V
Dynamic Resistance	typ Ω_{dyn}	0.02	0.03	0.02	0.05	Ω

Note 1: EP-Blue is recommended for new designs. Please see page 9 for part ordering numbers.

Note 2: All ratings are based on operation with a constant heat sink temperature $T_{hs} = 40^\circ\text{C}$. See Thermal Resistance section for T_{hs} definition.

Note 3: Parameters rated at typical duty cycle and Pulsed operation frequency $f > 240\text{Hz}$;



Note 4: Duty Cycle used to specify device ratings under Pulsed operation. PhlatLight devices can operate at duty cycles ranging from 1% to 100%. At higher duty cycles, drive current should be adjusted to maintain the junction temperature at desired levels to meet the application lifetime requirements.

Note 5: In pulsed operation, rise time from 10 to 90% of forward current should be larger than 0.5 microseconds

Note 6: For Blue and EP-Blue devices, total flux from emitting area at typical dominant wavelength.

Note 7: In CIE 1931 chromaticity diagram coordinates, normalized to $X+Y+Z=1$

Note 8: For Reference only

Note 9: Estimated median lifetime, assuming $T_j < 80^\circ\text{C}$ for Red devices, $T_j < 115^\circ\text{C}$ for Blue devices and $T_j < 125^\circ\text{C}$ for Green devices

Absolute Maximum Ratings

	Symbol	Red	Green	Blue	EP-Blue	Unit
Maximum Current ^{1,2}	Max	16	16	16	16	A
Absolute Maximum Junction Temperature ³	Max T_{jmax}	110	170	170	170	$^\circ\text{C}$
Storage Temperature Range		-40/+100	-40/+100	-40/+100	-40/+100	$^\circ\text{C}$

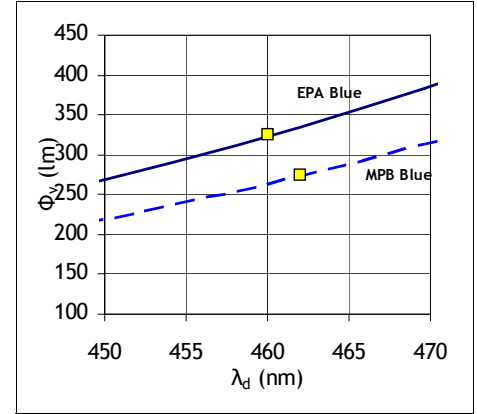
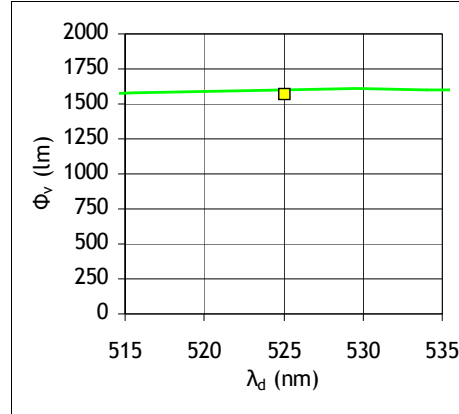
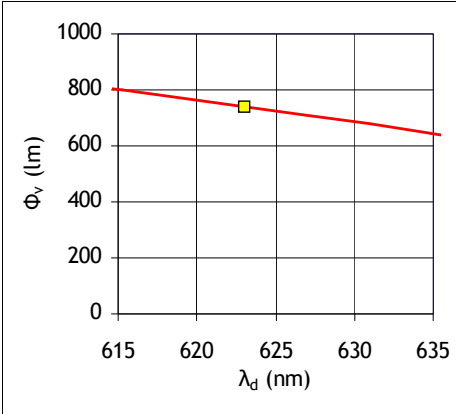
Note 1: Luminus PhlatLight LEDs are designed for operation to an absolute maximum forward drive current density of 2.5A/mm² cw, and 3A/mm² pulsed (f>240Hz, duty cycle < 60%). Please refer to absolute maximum rating table above for specific absolute maximum currents for the products covered in this datasheet.

Product lifetime data is specified at recommended forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to recommended forward drive currents. Actual device lifetimes will also depend on junction temperature. Refer to the lifetime derating curves for further information.

Note 2: In pulsed operation, rise time from 10 to 90% of forward current should be larger than 0.5 microseconds.

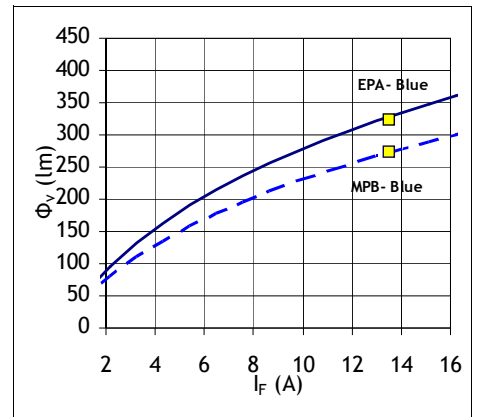
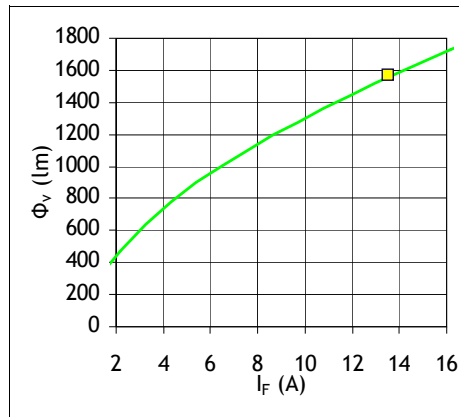
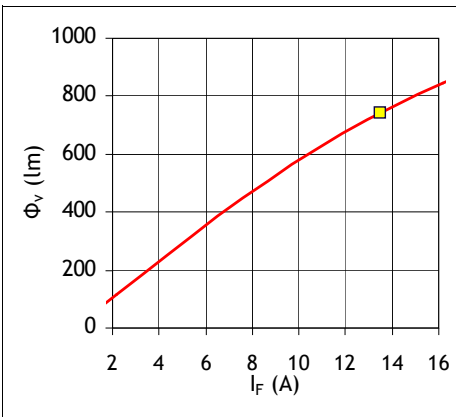
Note 3: Sustained operation above Maximum Operating Junction Temperature (T_{jmax}) will result in reduced device life time.

Luminous Flux variation with Wavelength: $\Phi_v = f(\lambda_d)$ at Recommended Operating Current I_F



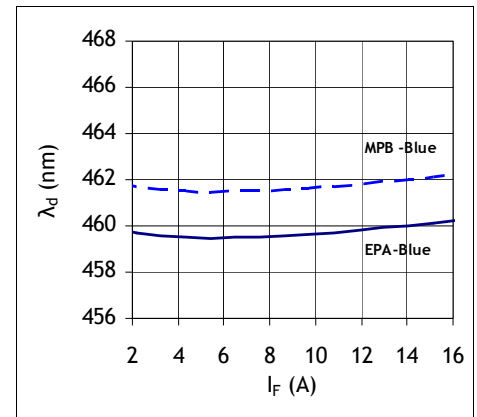
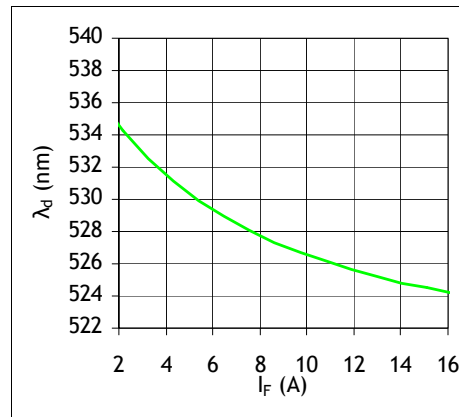
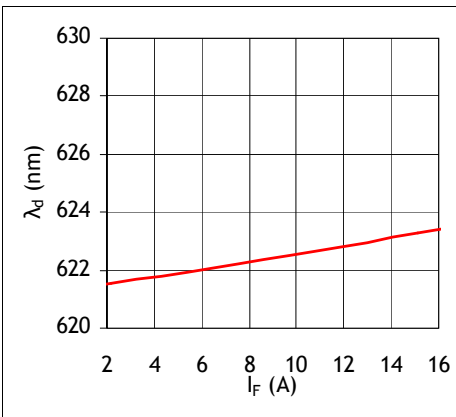
See note 1,2 on page 6

Luminous Flux variation with Drive Current - $\Phi_v = f(I_F)$ - Typical



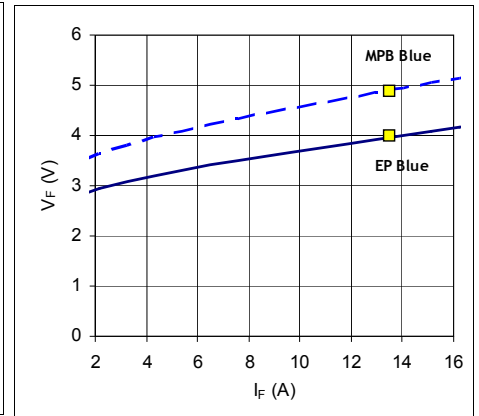
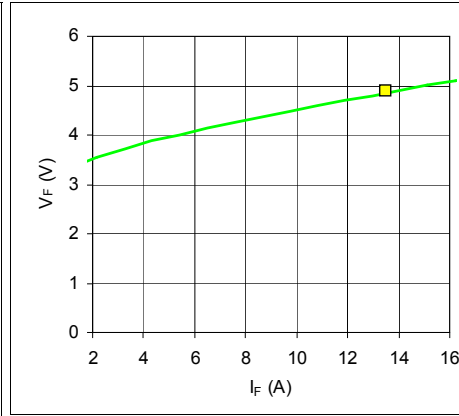
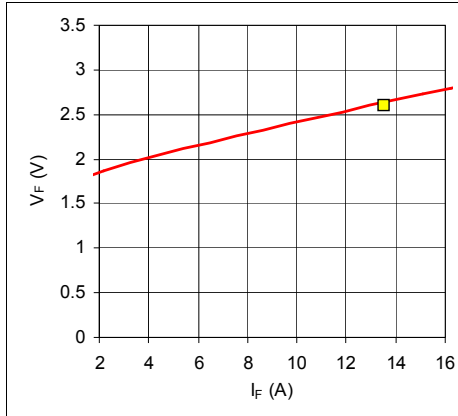
See notes 1,2 on page 6.

Dominant Wavelength variation with Forward Current - $\lambda_d = f(I_F)$ - Typical

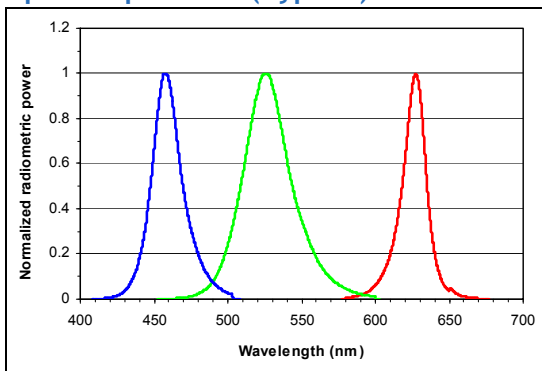


See notes 1,2 on page 6.

Forward Voltage variation with Drive current - $V_F = f(I_F)$ - Typical



Optical Spectrum (Typical)

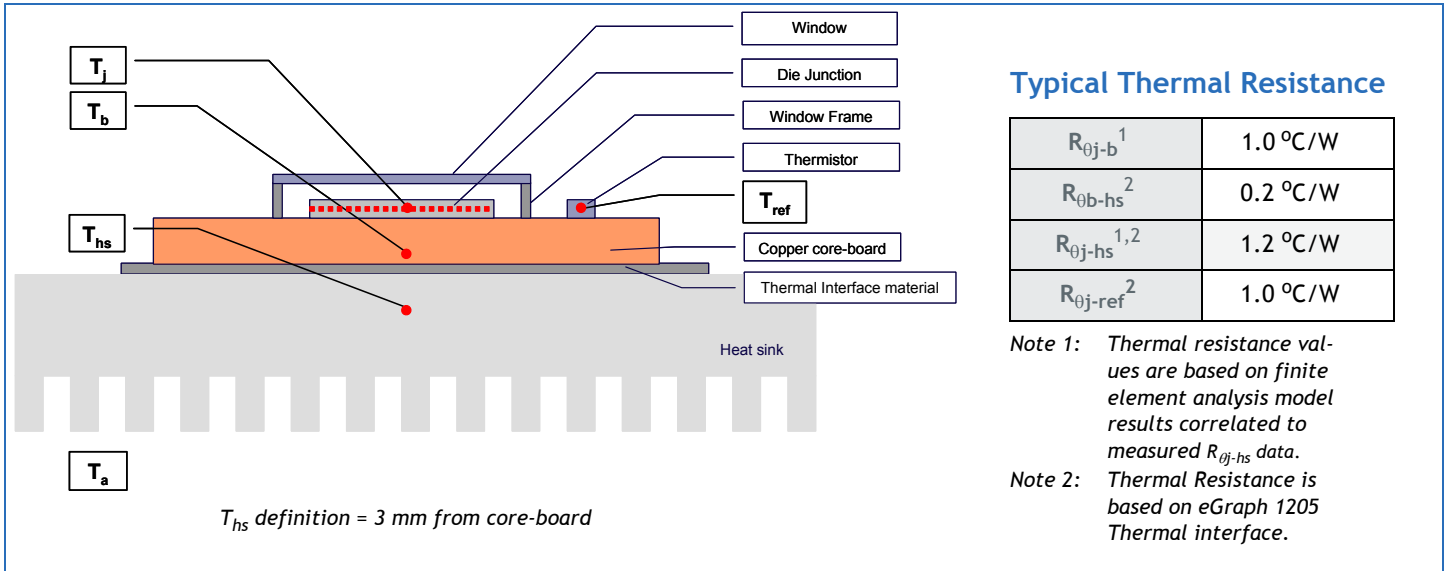


See note 3 on page 6.

Chart Notes

- Note 1:** For Pulsed operation, typical RGB duty cycles used are 25%, 50% and 25% respectively ($T_{hs}=40^{\circ}\text{C}$).
- Note 2:** Yellow square indicate device operating point under reference conditions listed in the Optical and Electrical Characteristics table.
- Note 3:** Typical Spectrum at recommended peak drive current.

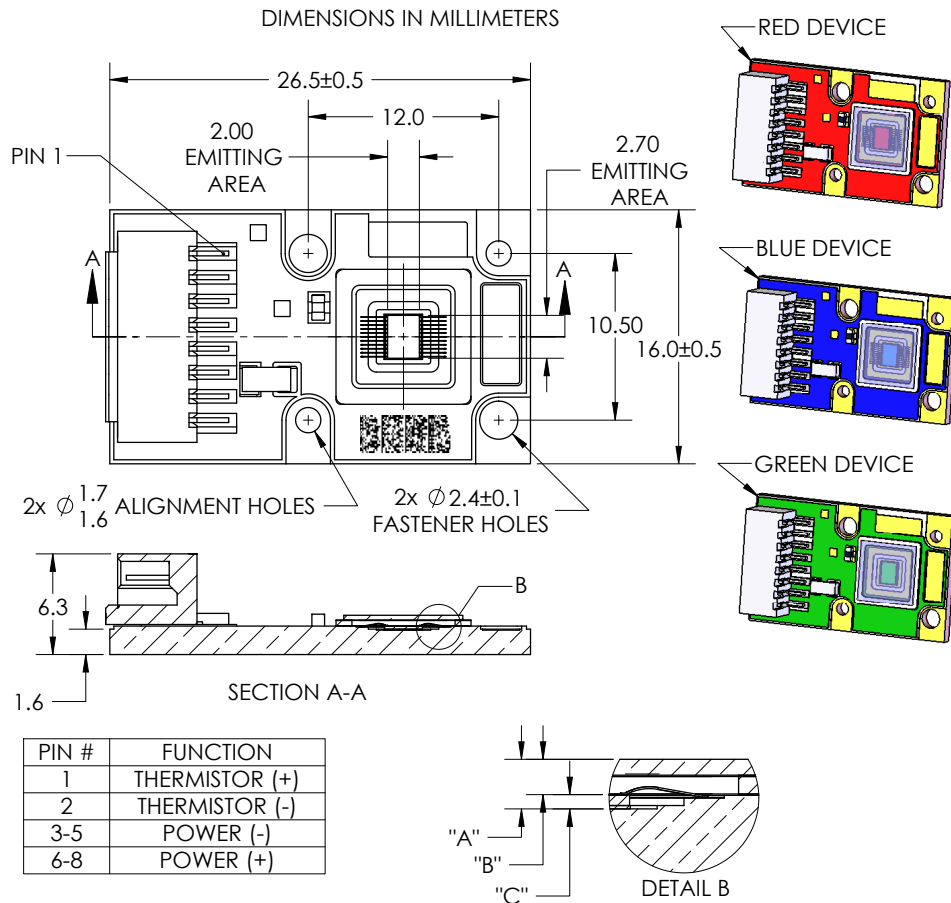
Thermal Resistance



Thermistor Information

The thermistor used in PhlatLight™ devices mounted on core-boards is from Murata Manufacturing Co. The global part number is NCP15XH103J03RC. Please see <http://www.murata.com/> or <http://www.murata.co.jp> for details on calculating thermistor temperature.

Mechanical Dimensions (Standard Die Configuration)



DIMENSION NAME	DESCRIPTION	NOMINAL DIMENSION	TOLERANCE
"A"	TOP OF METAL SUBSTRATE TO TOP OF GLASS	0.94	±0.13
"B"	EMITTING AREA TO TOP OF GLASS	0.67	±0.16
"C"	TOP OF METAL SUBSTRATE TO EMITTING AREA	0.27	±0.05

DWG-001262

- Red, Green and Blue PT54 PhlatLight™ LEDs are individually assembled into a Type CX, Common Anode Copper Core-Board with a footprint of 26.5 mm x 16 mm.
- Dimension above for information only. For detailed dimensions, always refer to the latest revision of the DWG-001262 package outline
- Connector: MOLEX. Part Number: 874380843. Please refer to DWG-001262 (separate document) for pin-out information

Ordering Information

Customer Part Number	Die Configuration	Color	Description
PT-54-R-C21-MPB	Standard	Red	Bin Kit MPB Red PhlatLight PT54 consisting of a 5.4mm ² LED, thermistor and connector mounted on a type CX copper-core PCB
PT-54-G-C21-MPB		Green	Bin Kit MPB Green PhlatLight PT54 consisting of a 5.4mm ² LED, thermistor and connector mounted on a type CX copper-core PCB
PT-54-B-C21-MPB ¹		Blue	Bin Kit MPB Blue PhlatLight PT54 consisting of a 5.4mm ² LED, thermistor and connector mounted on a type CX copper-core PCB
PT-54-B-C21-EPA ²		EP-Blue	Bin Kit EPA Blue PhlatLight PT54 consisting of a 5.4mm ² LED, thermistor and connector mounted on a type CX copper-core PCB

Note 1: *Not recommended for new designs.*

Note 2: *Bin Kit EPA Blue is recommended for new designs.*

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